



P-Channel 2.5 V (G-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)		
	0.055 at V _{GS} = - 4.5 V	- 5.3			
- 20	0.06 at V _{GS} = - 3.6 V	- 5.1	11		
	0.083 at V _{GS} = - 2.5 V	- 4.3			

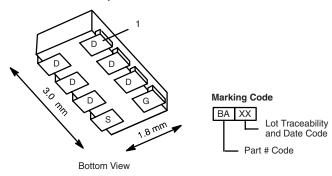
FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- 2.5 V Rated
- Compliant to RoHS Directive 2002/95/EC

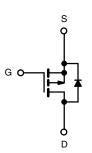




1206-8 ChipFET®



Ordering Information: Si5441DC-T1-E3 (Lead (Pb)-free) Si5441DC-T1-GE3 (Lead (Pb)-free and Halogen-free)



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	T _A = 25 °C, unle	ss otherwise n	oted			
Parameter		Symbol	5 s	Steady State	Unit	
Drain-Source Voltage		V_{DS}	- 20		V	
Gate-Source Voltage		V _{GS}	± 12		V	
Continuous Drain Current /T 150 °C\a	T _A = 25 °C	- I _D	- 5.3	- 3.9		
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 85 °C		- 3.8	- 2.8		
Pulsed Drain Current		I _{DM}	- 20		Α	
Continuous Source Current ^a		I _S	- 2.1	- 1.1		
Mariana Barra Biraira Kang	T _A = 25 °C	P _D	2.5	1.3	W	
Maximum Power Dissipation ^a	T _A = 85 °C		1.3	0.7		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C	
Soldering Recommendations (Peak Temperature) ^{b, c}			260			

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maniana Instituta In Antiqui	t ≤ 5 s	R _{thJA}	40	50	°C/W
Maximum Junction-to-Ambient ^a	Steady State		80	95	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	15	20	

Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. See Reliability Manual for profile. The ChipFET is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

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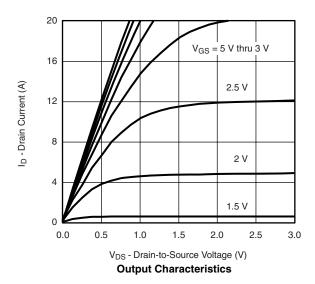
SPECIFICATIONS T _J = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = -250 \mu A$	- 0.6		- 1.4	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 12 V$			± 100	nA	
Zana Oata Wallana Busin Oamant	I _{DSS}	V _{DS} = - 20 V, V _{GS} = 0 V			- 1	uA	
Zero Gate Voltage Drain Current		V _{DS} = - 20 V, V _{GS} = 0 V, T _J = 85 °C			- 5		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 20			Α	
		$V_{GS} = -4.5 \text{ V}, I_D = -3.9 \text{ A}$		0.046	0.055		
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = -3.6 \text{ V}, I_D = -3.7 \text{ A}$		0.050	0.06	Ω	
		V _{GS} = - 2.5 V, I _D = - 3.1 A		0.070	0.083		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 3.9 A		12		S	
Diode Forward Voltage ^a	V_{SD}	I _S = - 1.1 A, V _{GS} = 0 V		- 0.8	- 1.2	V	
Dynamic ^b							
Total Gate Charge	Q_g			11	22		
Gate-Source Charge	Q _{gs}	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -3.9 \text{ A}$		3.0		nC	
Gate-Drain Charge	Q_{gd}			2.5			
Turn-On Delay Time	t _{d(on)}			20	30		
Rise Time	t _r	V_{DD} = - 10 V, R_L = 10 Ω		35	55		
Turn-Off Delay Time	t _{d(off)}	$I_D\cong$ - 1 A, $V_{GEN}=$ - 4.5 V, $R_g=6~\Omega$		65	100	ns	
Fall Time	t _f			45	70		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = - 1.1 A, dI/dt = 100 A/μs		30	60		

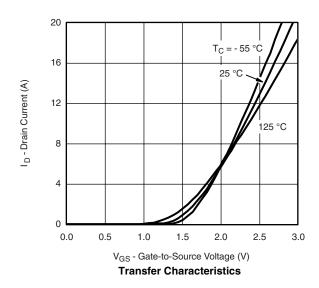
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



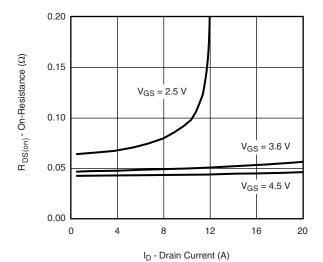




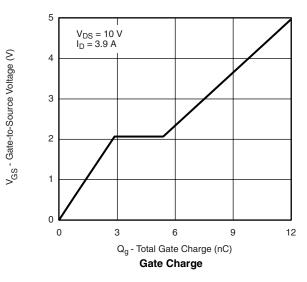


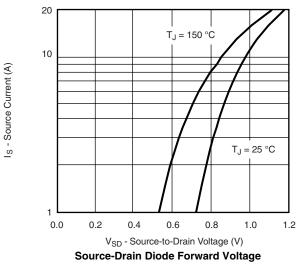


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



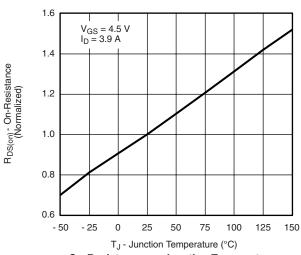
On-Resistance vs. Drain Current



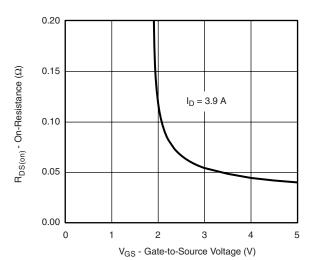


1800 1500 Ciss 1200 900 Coss 300 Crss 0 0 4 8 12 16 20

V_{DS} - Drain-to-Source Voltage (V) **Capacitance**



On-Resistance vs. Junction Temperature

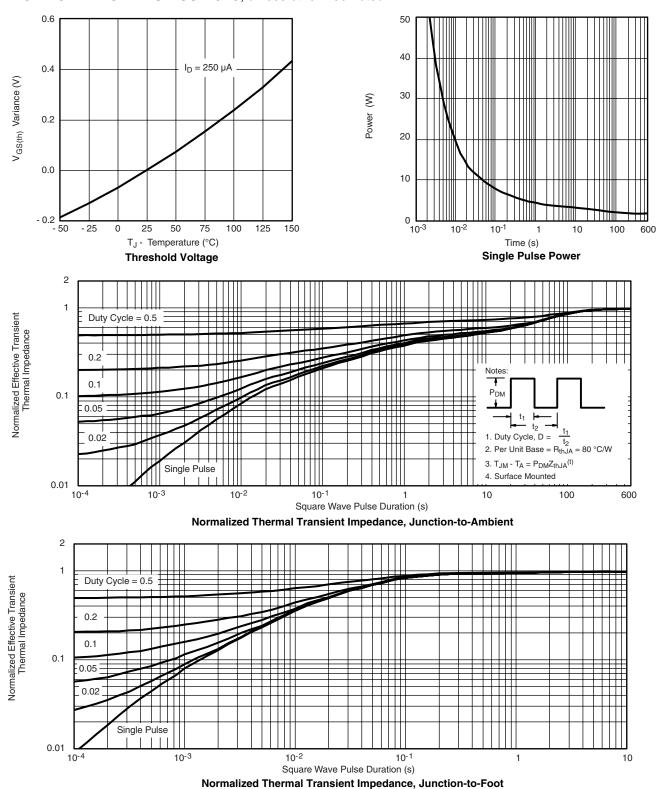


On-Resistance vs. Gate-to-Source Voltage

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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